

# **Excellent Integrated System Limited**

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Fairchild Semiconductor MPSA12

For any questions, you can email us directly: <u>sales@integrated-circuit.com</u>



			MPSA1
	MPSA12		N
<ul> <li>This device is current gain a</li> <li>Sourced from</li> <li>See MPSA14</li> </ul>	Agton Transistor designed for applications requiring extremely high t currents to 1.0A. process 05. for characteristics. Maximum Ratings * T <sub>A</sub> =25°C unless otherwise no	1 Emitter 2. Ba	TO-92 ise 3. Collector
Symbol	Parameter	Value	Units
V <sub>CES</sub>	Collector-Emitter Voltage	20	V
V <sub>CBO</sub>	Collector-Base Voltage	20	V
V <sub>EBO</sub>	Emitter-Base Voltage	10	V

NOTES:

Ι<sub>C</sub> T<sub>J</sub>, T<sub>STG</sub>

Collector Current

These ratings are based on a maximum junction temperature of 150 degrees C.
 These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Operating and Storage Junction Temperature Range

\* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

- Continuous

1.2

-55 ~ +150

А

°C

## Electrical Characteristics TA=25°C unless otherwise noted

Т		Т	Test C	Condi	tion		Min.		Тур.	Max.	Uni
= 100	I <sub>C</sub> =	= 100	)μΑ, Ι <sub>Ε</sub>	<sub>E</sub> = 0			20				V
<sub>B</sub> = 15	V <sub>CB</sub>	<sub>B</sub> = 15	5V, I <sub>E</sub>	= 0						100	n/
<sub>B</sub> = 15	V <sub>CB</sub>	<sub>B</sub> = 15	5V, I <sub>C</sub>	) = 0						100	n/
<sub>B</sub> = 10	V <sub>EB</sub>	<sub>B</sub> = 10	0V, I <sub>C</sub>	; = 0						100	n/
<sub>E</sub> = 5.	V <sub>CE</sub>	<sub>E</sub> = 5.	5.0V, I <sub>C</sub>	<sub>C</sub> = 10	)mA		20,000	)			
= 10m	I <sub>C</sub> =	= 10m	mA, I <sub>B</sub>	$_{3} = 0.0$	1mA					1.0	V
= 10m	I <sub>C</sub> =	= 10m	nΑ, V <sub>o</sub>	<sub>CE</sub> = 5	5.0V					1.4	V
= 10m	I <sub>C</sub> =	= 10m	mA, V <sub>o</sub>	<sub>CE</sub> = 5	5.0	V	V	V	V	V	V 1.4

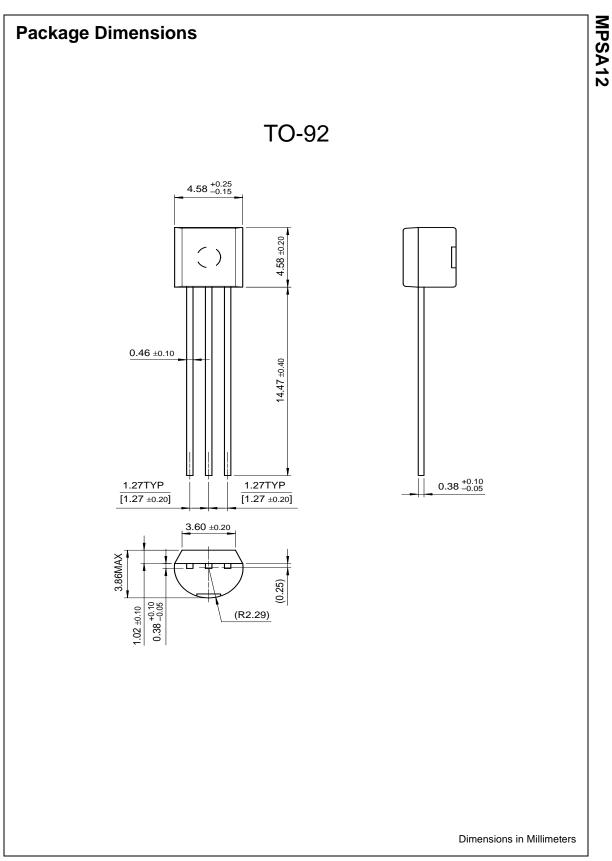
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## Thermal Characteristics TA=25°C unless otherwise noted

Symbol	Parameter	Max.	Units
PD	Total Device Dissipation	625	mW
	Derate above 25°C	5.0	mW/°C
$R_{\thetaJC}$	Thermal Resistance, Junction to Case	83.3	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	200	°C/W

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	EcoSPARK™	GTO™	MSX™	QT Optoelectronics <sup>™</sup>	TinyLogic™
	E <sup>2</sup> CMOS™	HiSeC™	MSXPro™	Quiet Series™	TruTranslation™
	EnSigna™	I <sup>2</sup> C <sup>™</sup>	OCX™	RapidConfigure™	UHC™
	Across the board.	Around the world. <sup>™</sup>	OCXPro™	RapidConnect™	UltraFET®
The Power Franchise™			OPTOLOGIC <sup>®</sup>	SILENT SWITCHER <sup>®</sup>	VCX™
	Programmable Ac	ctive Droop™	OPTOPLANAR™	SMART START™	

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